

NPS10N65F

650V N-Channel Enhancement Mode Power MOSFET



VOLTAGE:	650 Volts	CURRENT:	10.0 Amperes	TO-220F	Marking and Polarity
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FEATURES

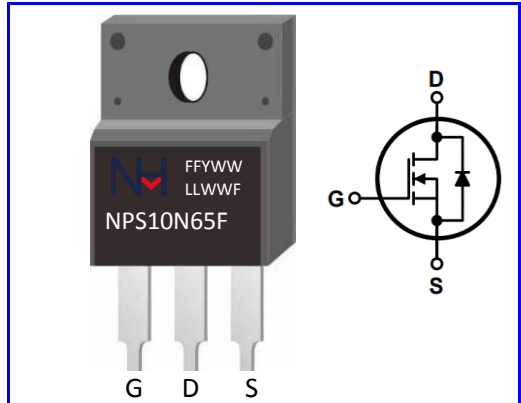
- Low RDS(ON)
- Ultra Low Gate Charge
- RoHS Compliant
- 100% UIS and RG Tested

TYPICAL APPLICATIONS

- Adapter,PC,PD,Charger,LED Driver
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

PRODUCT SUMMARY

VDS@T _J MAX.	650	V
ID	10.0	A
RDS(ON) ,Typ.@10V	0.84	Ω



Remark:

- NH=niuhang trademark;
- FF=Product line code,According to actual changes
YWW=Data code,According to actual changes
LLWWF=Internal code,According to actual changes
- NPS10N65F=Module.

Absolute Maximum Ratings (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Test Conditions	Symbol	Ratings	Unit
Drain-Source Voltage		V _{DS}	650	V
Gate-Source Voltage		V _{GS}	±30	V
Continuous Drain Current (Note 1)	Ta= 25 °C Ta= 100 °C	I _D	10 6.4	A
Drain Current-Pulsed (Note 1)	T _J < 150 °C	I _{DM}	40	A
Maximum Power Dissipation	Ta= 25 °C	P _D	42	W
Power Dissipation Derating Factor above 25°C	Ta= 100 °C		17	
Derating Factor		D _F	0.33	W/°C
Junction Temperature		T _J	-55 to 150	°C
Storage temperature range		T _{STD}	-55 to 150	°C
Avalanche Current,Single pulse	L= 10 mH	I _{AS}	10	A
Single Pulse Avalanche Energy	L= 10 mH,VDD=15V IAS= 10 A,RG=25Ω Starting T _J =25°C	E _{AS}	500	mJ

Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Test Conditions	Symbol	Typ.	Unit
Thermal Resistance Junction to Ambient(Note 2)	1.still air environment with TA =25° C.	R _{θJA}	62.5	°C/W
Thermal Resistance Junction-Case(Note 2)	2.device mounted on 1 in ² FR-4 board with 2oz	R _{θJC}	3.0	

Notes:

- Repetitive Rating : Pulse width limited by maximum junction temperature
- The value of R_{θJA} is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with TA =25° C.
The value in any given application depends on the user's specific board design.This transistor is sensitive to electrostatic discharge and should be handled with care.



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Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Static off Characteristics						
Drain-Source Breakdown Voltage	VGS=0V, ID=250uA	BV_{DSS}	650	-	-	V
Bvdss Temperature Coefficient	ID=250uA, Reference 25°C	$\Delta BV_{DSS}/\Delta T_J$	-	0.67	-	V/°C
Drain-Source Leakage Current	VDS= 650 V, VGS=0V	I_{DSS}	-	-	1	uA
Gate-Body Leakage Current	VGS= ±30 V, VDS=0V	I_{GSS}	-	-	±100	nA
Static on Characteristics						
Gate Threshold Voltage	VGS= VDS ID=250uA	$V_{GS(TH)}$	2.0	3.0	4.0	V
Drain-Source On Resistance	ID= 5 A, VGS=10V	$R_{DS(ON)}$	-	0.84	1.0	Ω
Dynamic Characteristics						
Input Capacitance	VDS= 25 V	C_{iss}	-	1609	-	pF
Output Capacitance	VGS= 0 V	C_{oss}	-	136	-	pF
Reverse Transfer Capacitance	F= 1 MHz	C_{rss}	-	7.5	-	pF
Switching Paramters						
Turn-On Delay Time	VDS= 325 V	$t_{d(on)}$	-	20	-	ns
Turn-On Rise Time	ID= 10 A	t_r	-	30	-	ns
Turn-Off Delay Time	VGS= 10 V	$t_{d(off)}$	-	90	-	ns
Turn-Off Rise Time	RG= 25 Ω	t_f	-	40	-	ns
Total Gate Charge	VDS= 520 V	Q_g	-	32	-	nC
Gate-Source Charge	ID= 10 A	Q_{gs}	-	8	-	nC
Gate-Drain Charge	VGS= 10 V	Q_{gd}	-	12	-	nC
Drain-Source Diode Characteristics and Maximum Ratings						
Max. Diode Forward Current		I_S	-	-	10	A
Max. Pulsed Forward Current		I_{SM}	-	-	40	A
Diode Forward Voltage	ID= 10 A, VGS=0V	V_{SD}	-	0.85	1.4	V
Reverse Recovery Time	ID= 10 A, VGS=0V	t_{rr}	-	385	-	ns
Reverse Recovery Charge	di/dt= 100 A/us	Q_{rr}	-	3	-	μC

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Typical Characteristics Curves

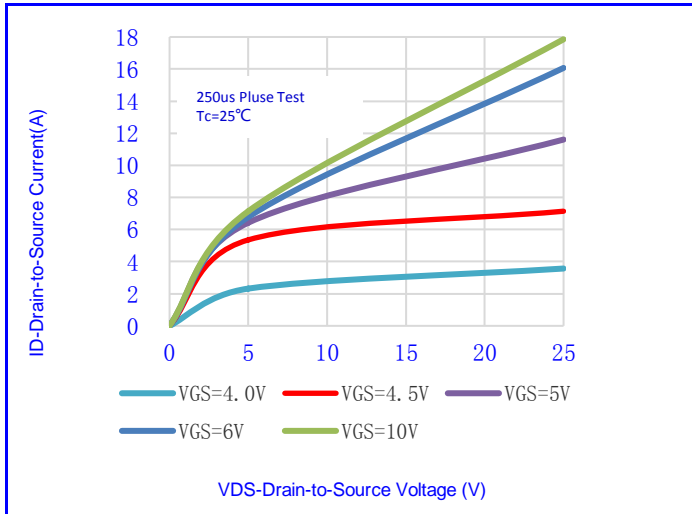


Fig.1-Output Characteristics

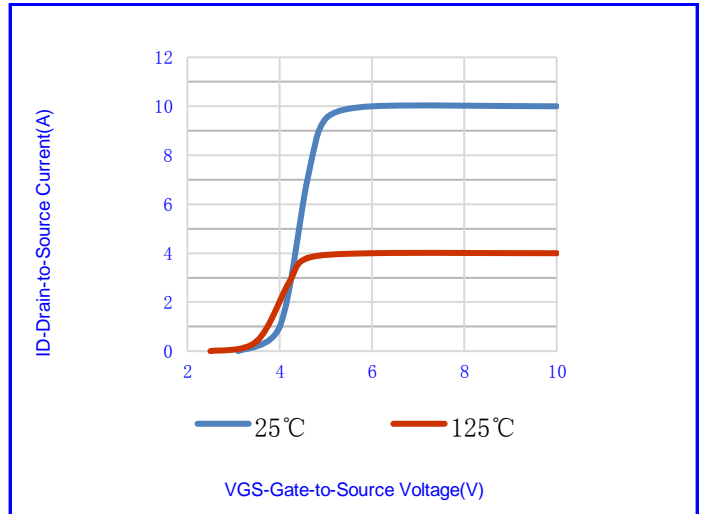


Fig.2- Transfer Characteristics

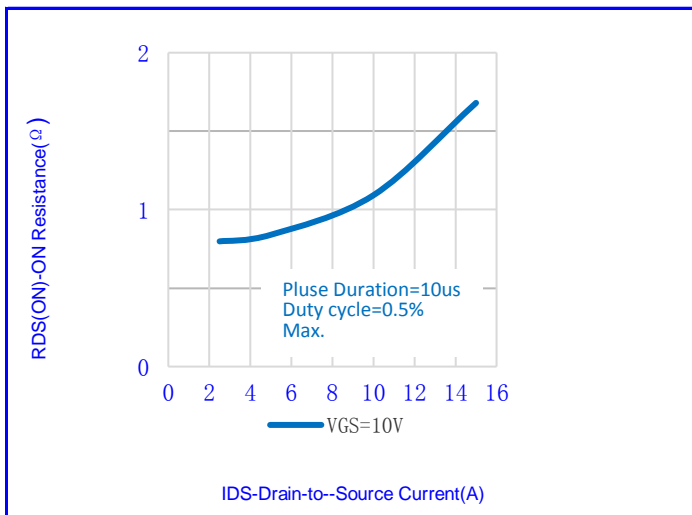


Fig.3- On Resistance vs. Drain Current

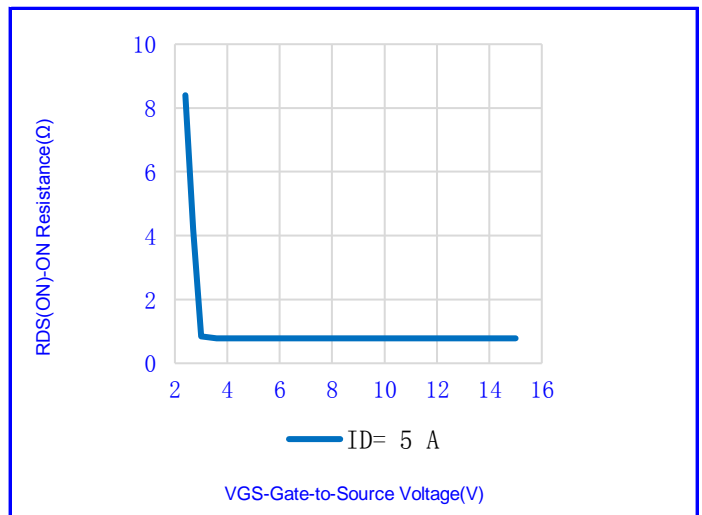


Fig.4- On Resistance vs. Gate Source Voltage

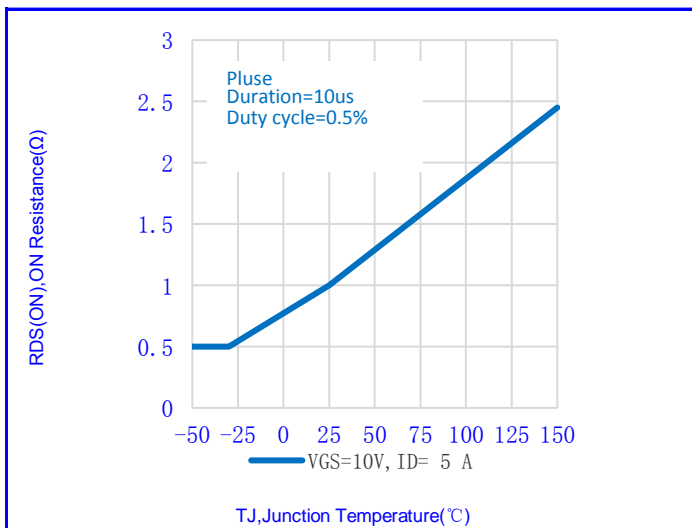


Fig.5- On Resistance vs. Junction Temperature

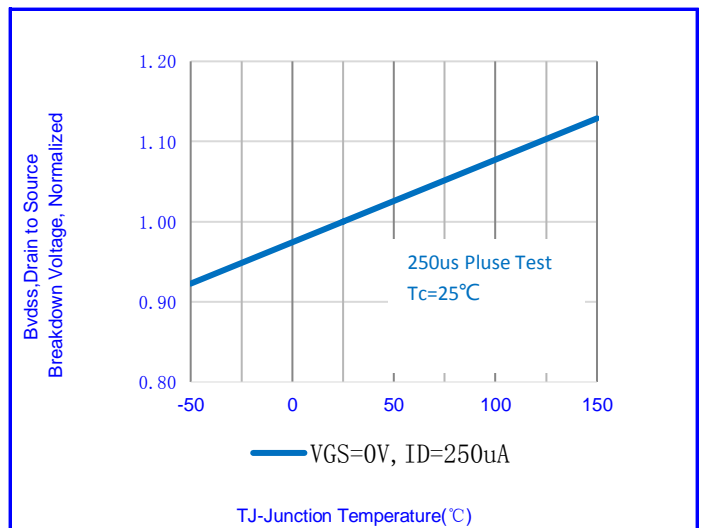


Fig.6- Breakdown Voltage vs. Junction Temperature

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Typical Characteristics Curves

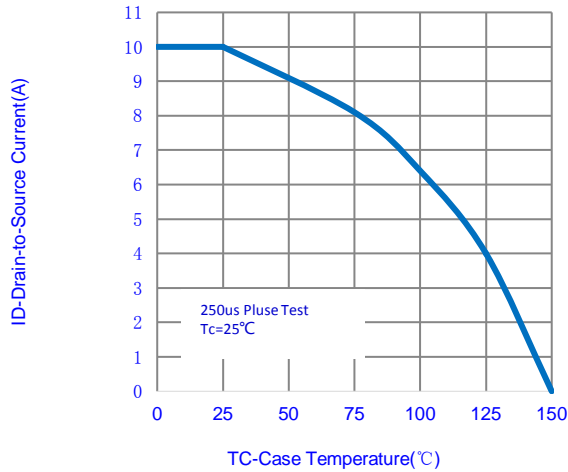


Fig.7-Maximum Continuous Drain Current vs. Case Temperature

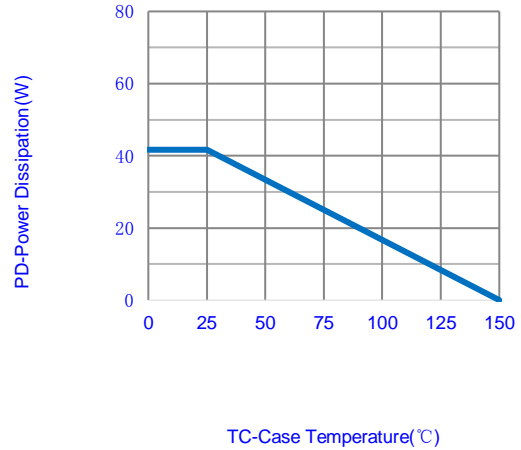


Fig.8-Maximum Power Dissipation vs. Case Temperature

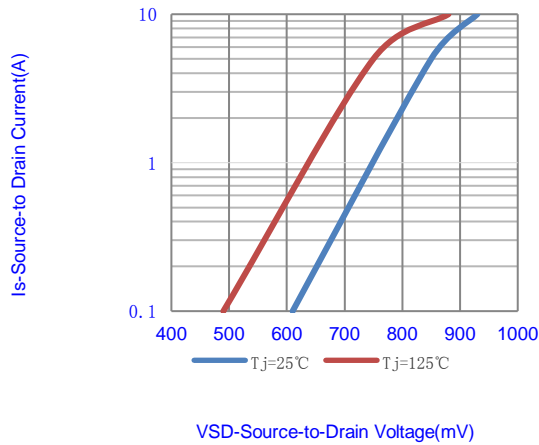


Fig.9- Source-Drain Diode Forward Voltage

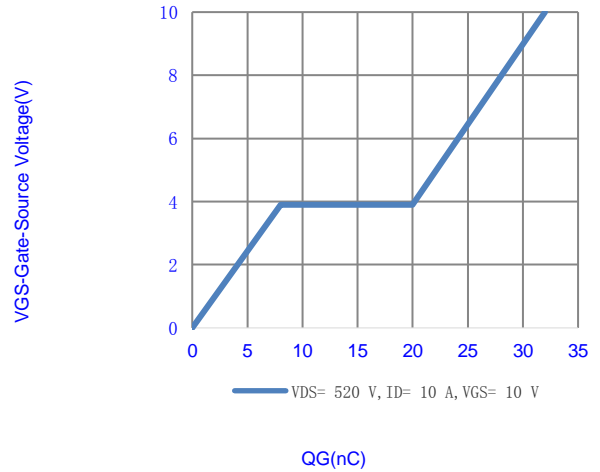


Fig.10-Gate Charge Waveform

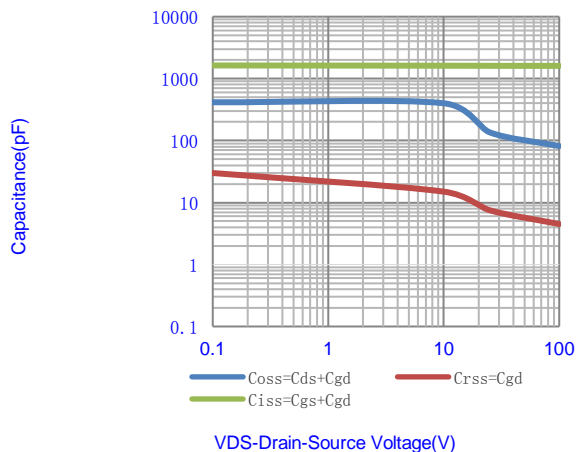


Fig.11- Gate-Source Voltage-VGS(V)

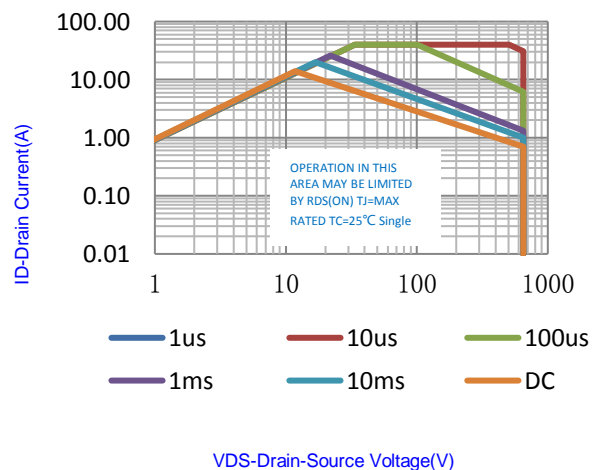


Fig.12-Maximum Safe Operating Area(SOA)

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Typical Characteristics Curves

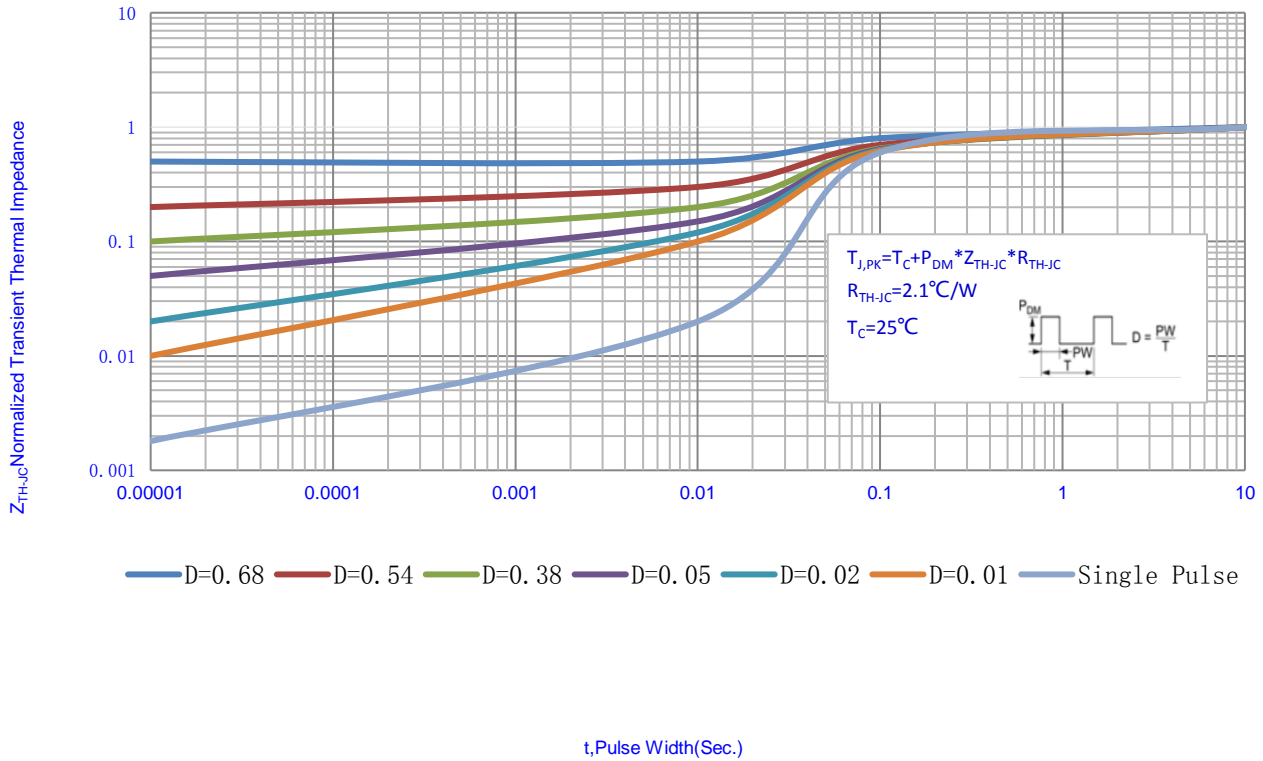


Fig.13- Normalized Transient Thermal Impedance vs. Pulse Width

Test Circuit & Waveform

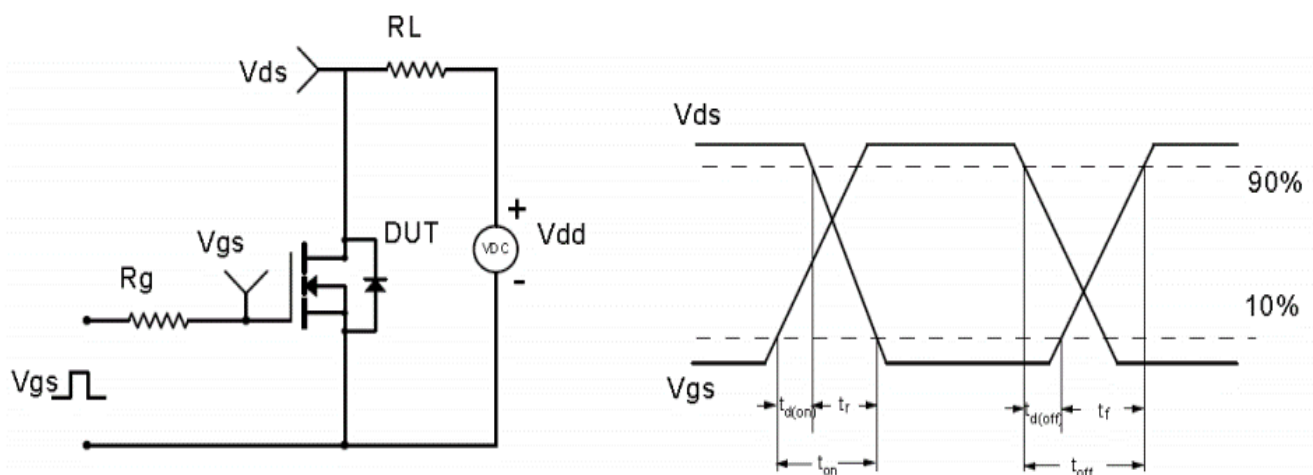


Fig.14- Resistive Switching Test Circuit & Waveform

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Test Circuit & Waveform

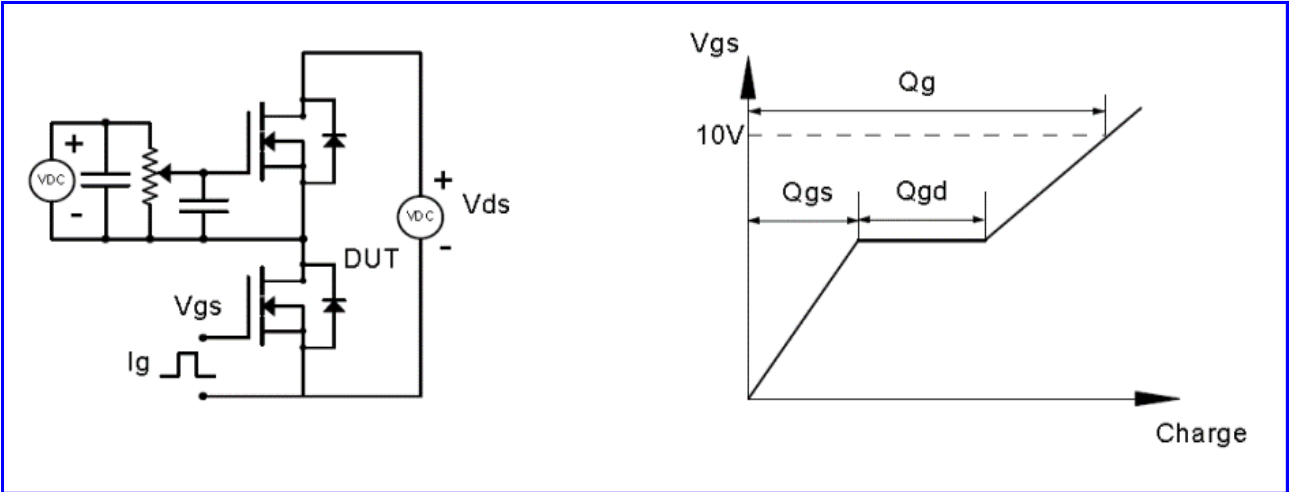


Fig.15- Gate Charge Test Circuit & Waveform

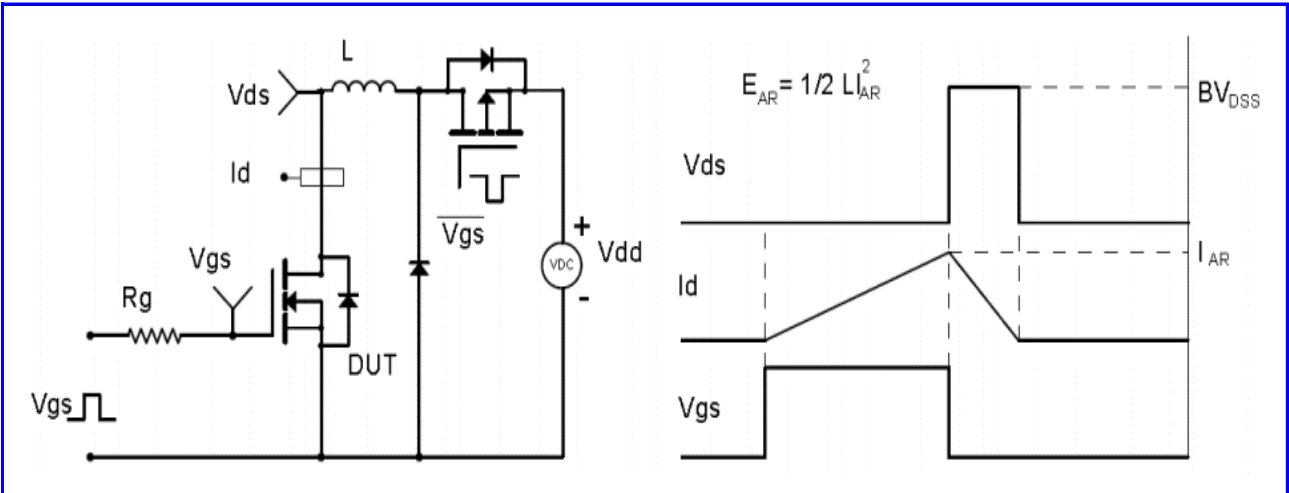


Fig.16- EAS Test Circuit & Waveform

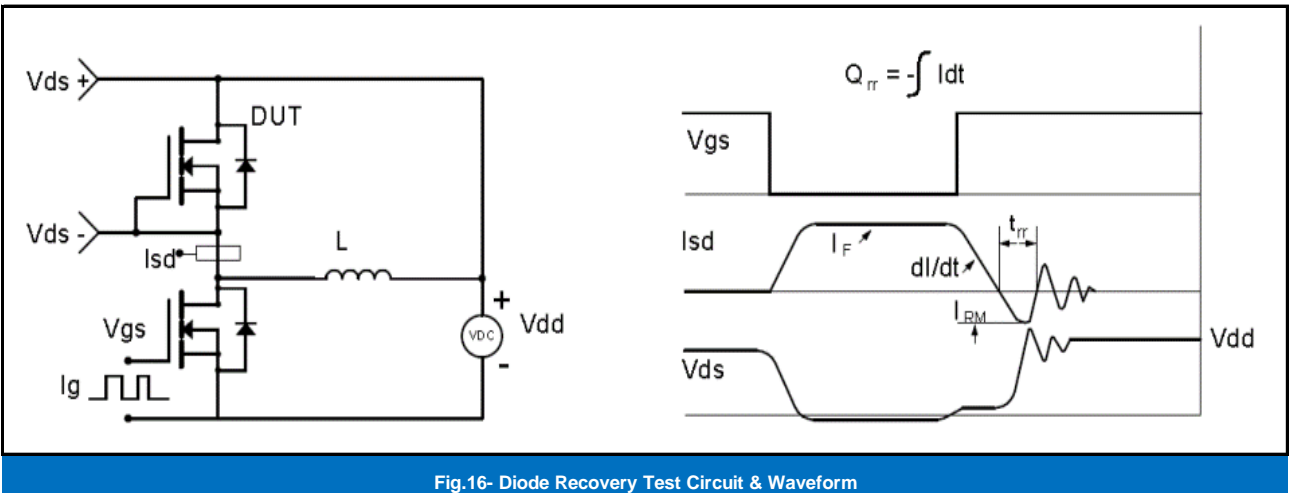


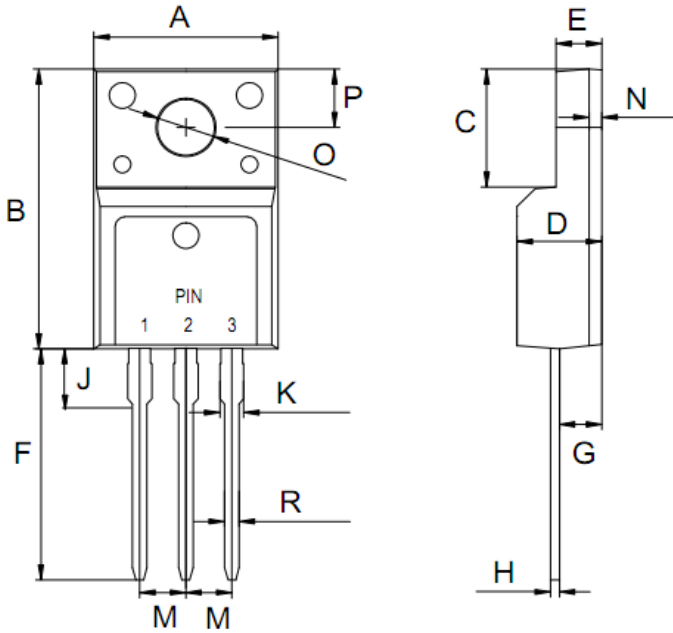
Fig.16- Diode Recovery Test Circuit & Waveform

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OUTLINE DRAWINGS



TO-220F

OUTLINE DIMENSIONS						
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	10.00	-	10.50	0.39	-	0.41
B	15.40	-	16.20	0.61	-	0.64
C	6.48	-	6.88	0.26	-	0.27
D	4.50	-	4.90	0.18	-	0.19
E	2.35	-	2.75	0.09	-	0.11
F	12.50	-	-	0.49	-	-
G	2.40	-	3.00	0.09	-	0.12
H	0.40	-	0.60	0.02	-	0.02
J	2.20	-	4.20	0.09	-	0.17
M	2.40	-	2.70	0.09	-	0.11
N	0.80	-	1.10	0.03	-	0.04
K	1.20	-	1.50	0.05	-	0.06
R	0.60	-	1.00	0.02	-	0.04
O	3.10	-	3.70	0.12	-	0.15
P	3.00	-	4.00	0.12	-	0.16

PACKING INFORMATION

TO-220F

Package Method	Reel Size (mm)	Quantity (pcs/reel)	Inner Box Size LxWxH(mm)	Quantity (pcs/Inner Box)	Outer Carton Size LxWxH(mm)	Quantity (pcs/carton)
Tape Reel	Φ330	2500	340x340x50	5000	360x360x260	25000

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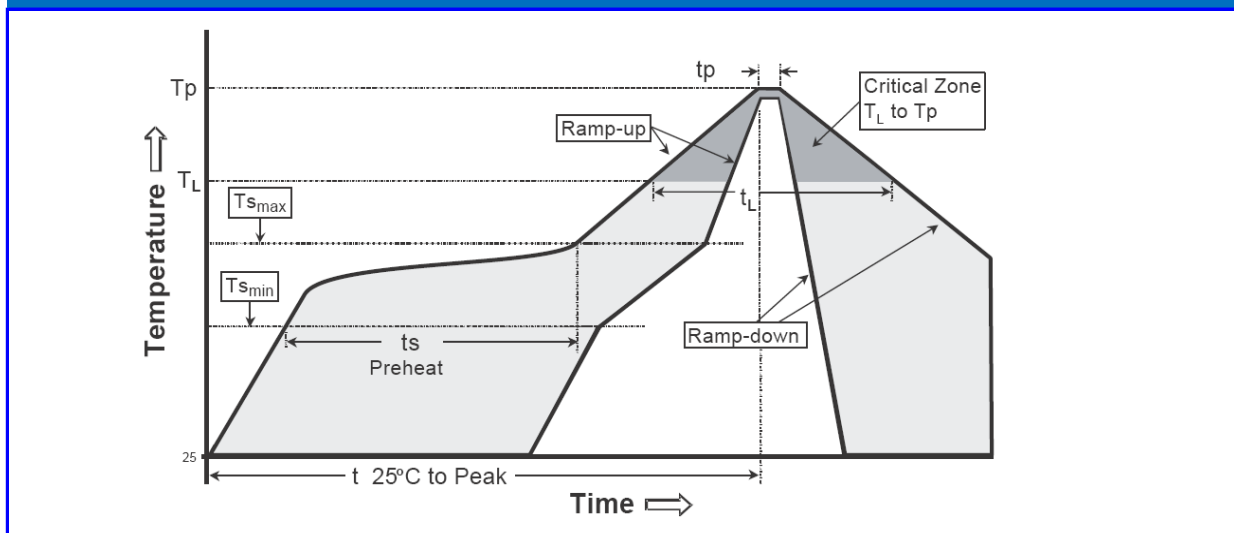
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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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